

8961726 TEXAS INSTR (OPTO)

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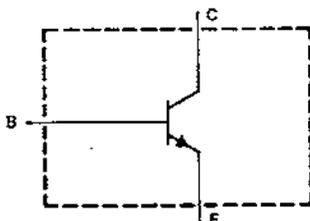
**BUX82, BUX83**  
**N-P-N SILICON POWER TRANSISTORS**

T-33-11

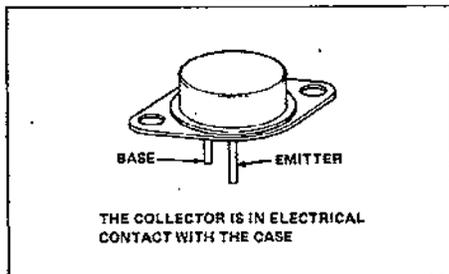
OCTOBER 1982 - REVISED OCTOBER 1984

- 60 W at 50°C Case Temperature
- 6 A Continuous Collector Current
- 8 A Peak Collector Current
- Series Features High-Voltage and Peak Current Ratings, Low Saturation Voltages, and a High Degree of Electrical Robustness
- Designed for Switching-Mode Power Supplies, CRT Scanning, Inverters, and Other Industrial Applications, Where Rapid Switching of Inductive Loads is Necessary

## device schematic



TO-3 PACKAGE



## absolute maximum ratings at 25°C case temperature (unless otherwise noted)

	BUX82	BUX83
Collector-base voltage	800 V	1000 V
Collector-emitter voltage ( $V_{GE} = 0$ )	800 V	1000 V
Collector-emitter voltage ( $I_B = 0$ )	400 V	450 V
Continuous collector current	6 A	
Peak collector current (see Note 1)	8 A	
Continuous base current	2 A	
Peak base current (see Note 1)	3 A	
Continuous device dissipation at (or below) 50°C case temperature	60 W	
Operating junction temperature	-65°C to 150°C	

NOTE 1: These values apply for  $t_w = 2$  ms, duty cycle  $\leq 2\%$ .

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**BUX82, BUX83**  
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electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	BUX82			BUX83			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
V <sub>CEO(sus)</sub>	I <sub>C</sub> = 0.1 A, L = 25 mH, See Note 2	400			460			V
V <sub>CER(sua)</sub>	I <sub>C</sub> = 0.1 A, L = 15 mH, R <sub>BE</sub> = 100 Ω, See Note 2	500			500			V
I <sub>CEO</sub>	V <sub>CE</sub> = 400 V, I <sub>B</sub> = 0			1				μA
	V <sub>CE</sub> = 450 V, I <sub>B</sub> = 0					1		
I <sub>CES</sub>	V <sub>CE</sub> = 800 V, V <sub>BE</sub> = 0			1				μA
	V <sub>CE</sub> = 1000 V, V <sub>BE</sub> = 0					1		
	V <sub>CE</sub> = 800 V, V <sub>BE</sub> = 0, T <sub>C</sub> = 125°C				150			
	V <sub>CE</sub> = 1000 V, V <sub>BE</sub> = 0, T <sub>C</sub> = 125°C						150	
I <sub>EBO</sub>	V <sub>EB</sub> = 10 V, I <sub>C</sub> = 0			1		1		mA
V <sub>CE(sat)</sub>	I <sub>C</sub> = 2.5 A, I <sub>B</sub> = 0.5 A			1		1		V
	I <sub>C</sub> = 4 A, I <sub>B</sub> = 1.25 A			2		2		
V <sub>BE(sat)</sub>	I <sub>C</sub> = 2.5 A, I <sub>B</sub> = 0.5 A			1.2		1.2		V
	I <sub>C</sub> = 4 A, I <sub>B</sub> = 1.25 A			1.4		1.4		
h <sub>FE</sub>	V <sub>CE</sub> = 5 V, I <sub>C</sub> = 0.6 A, See Note 3	40			40			
f <sub>T</sub>	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 0.2 A, See Note 4	12			12			MHz
C <sub>obp</sub>	V <sub>CB</sub> = 20 V, I <sub>C</sub> = 0, f = 0.1 MHz	110			110			pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, t<sub>w</sub> = 300 μs, duty cycle ≤ 2%.4. To obtain f<sub>T</sub>, the |h<sub>fe</sub>| response is extrapolated at the rate of -6 dB per octave from f = 1 MHz to the frequency at which |h<sub>fe</sub>| = 1.

## thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
R <sub>θJC</sub>		1.65		°C/W

resistive-load switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT
t <sub>on</sub>	I <sub>C</sub> = 2.5 A, V <sub>CC</sub> = 250 V, T <sub>C</sub> = 25°C, I <sub>B1</sub> = 0.5 A, I <sub>B2</sub> = -1 A, See Figure 1			0.4		μs
t <sub>s</sub>				2.5		μs
t <sub>f</sub>				0.25		μs
t <sub>on</sub>	I <sub>C</sub> = 2.5 A, V <sub>CC</sub> = 250 V, T <sub>C</sub> = 100°C, I <sub>B1</sub> = 0.5 A, I <sub>B2</sub> = -1 A, See Figure 1			0.8		μs
t <sub>s</sub>				3		μs
t <sub>f</sub>				0.5		μs


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## PARAMETER MEASUREMENT INFORMATION

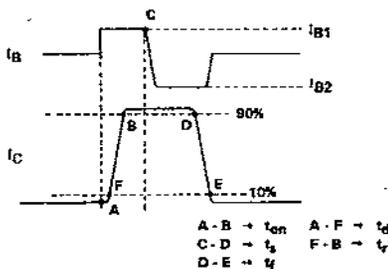
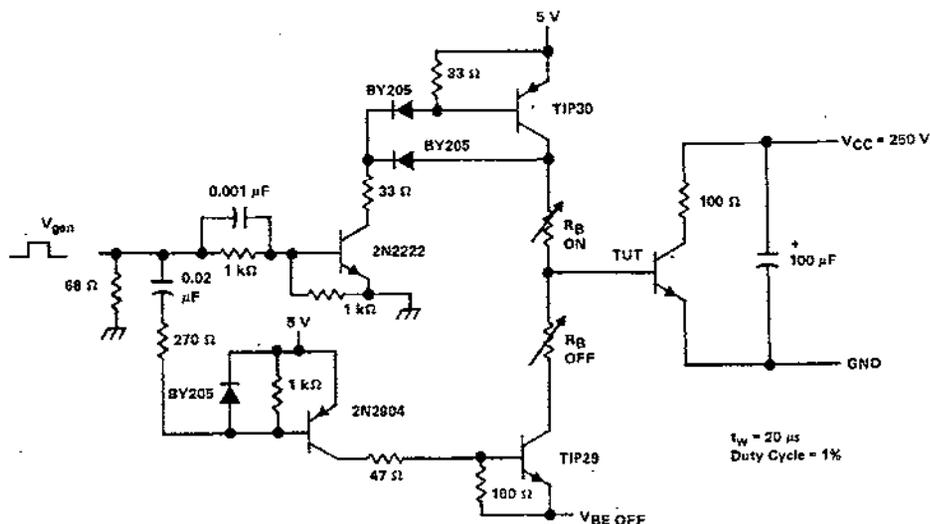


FIGURE 1. RESISTIVE-LOAD SWITCHING

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## TYPICAL CHARACTERISTICS

TURN-ON TIMES  
vs  
COLLECTOR

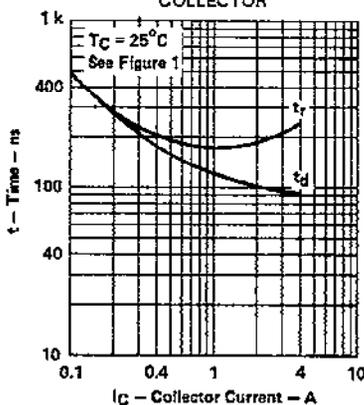


FIGURE 2

TURN-OFF TIMES  
vs  
COLLECTOR

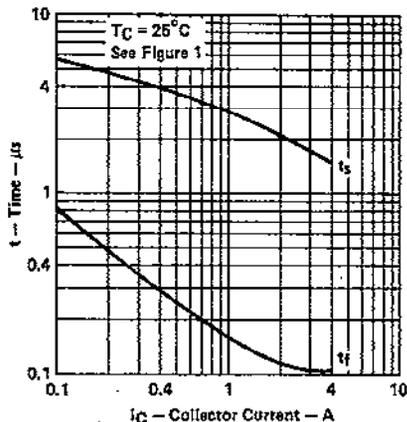


FIGURE 3

COLLECTOR-EMITTER SATURATION VOLTAGE  
vs  
BASE CURRENT

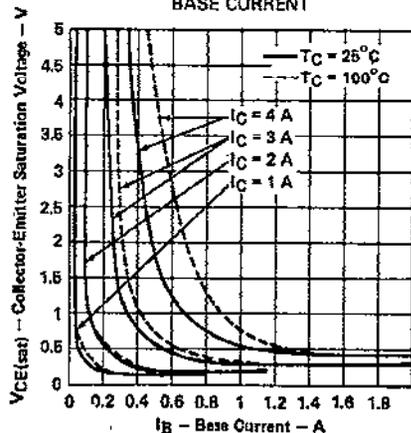


FIGURE 4

BASE-EMITTER SATURATION VOLTAGE  
vs  
BASE CURRENT

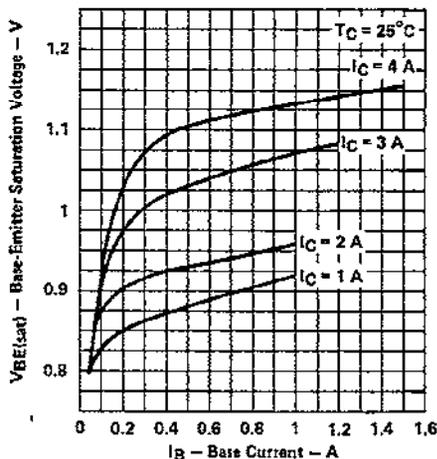


FIGURE 5

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TYPICAL CHARACTERISTICS

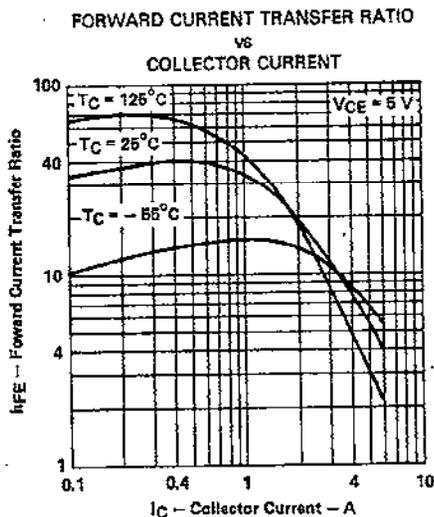


FIGURE 6

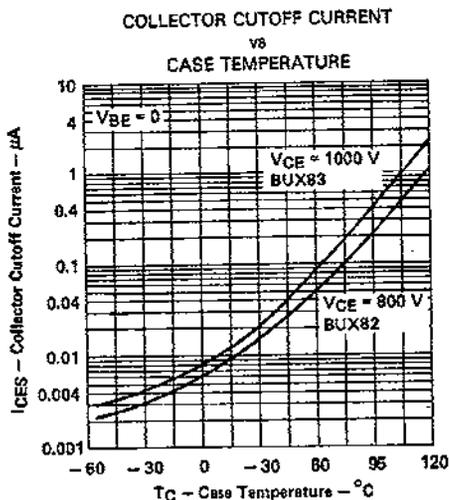


FIGURE 7

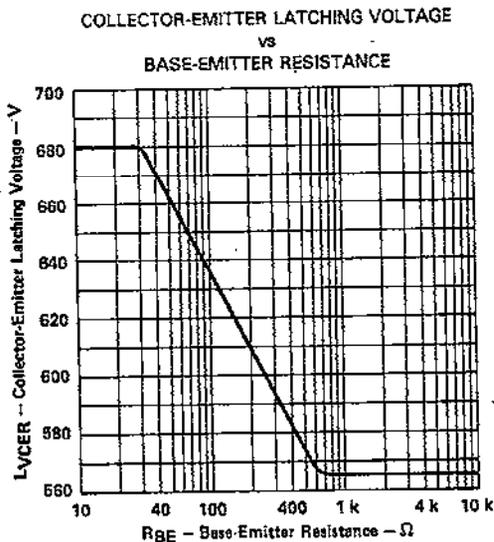


FIGURE 8



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## MAXIMUM SAFE OPERATING AREAS

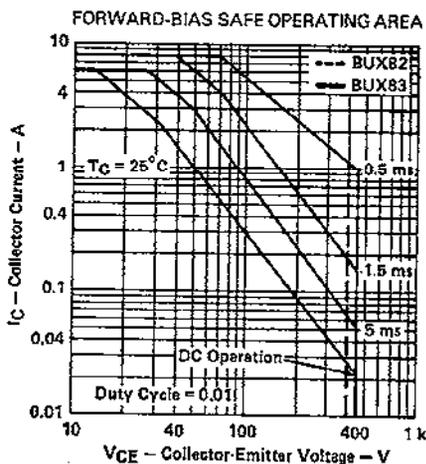


FIGURE 9

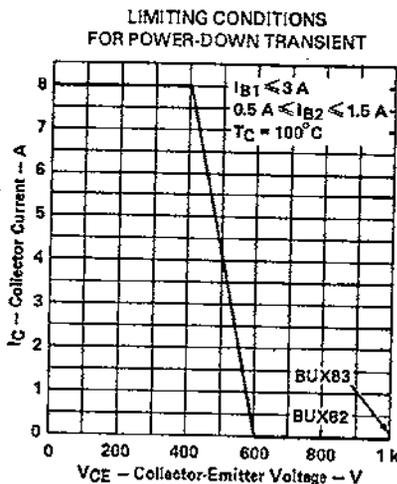


FIGURE 10

## THERMAL INFORMATION

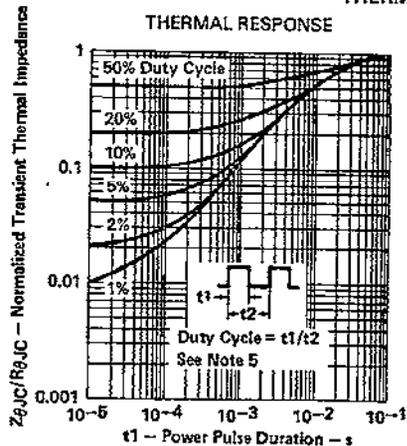


FIGURE 11

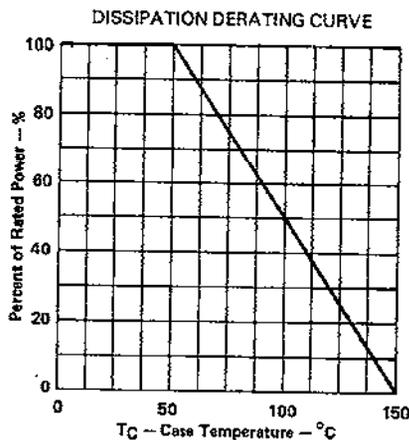


FIGURE 12

NOTE 7: Read time at end of  $t_1$ ,  $T_{J(\max)} - T_C = P_{D(\text{peak})} \cdot \left(\frac{Z_{\theta JC}}{R_{\theta JC}}\right) = R_{\theta JC(\max)}$ .

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